



ULTRA COMPACT CHIP ANTENNA DATA GUIDE

DESCRIPTION

The exciting ANT-***-CHP family is among the world's smallest high-performance chip antennas. They are ideal for embedding in wireless products including Bluetooth, 802.11, Home RF, ZigBee and other popular standards. These tiny antennas use advanced Low Temperature Co-fired Ceramic (LTCC) technology and proprietary elements to achieve superior size and performance characteristics. The entire family is compatible with hand- and reflow-assembly. Excellent electrical specifications, stability, and outstanding cost-effectiveness make CHP Series antennas the logical choice for a wide variety of applications.

FEATURES

- Incredibly compact SMD package
- Superior LTCC technology
- 50Ω characteristic impedance
- Low loss
- Wide bandwidth
- Favorable linear polarization
- > Unity gain
- No external matching required
- Highly stable over temperature & time
- Hand- and reflow-assembly compatible
- RoHS compliant
- Cost-effective

APPLICATIONS

- Bluetooth
- 802.11
- ZigBee
- Wireless PCMCIA Cards
- Telemetry
- Data Collection
- Industrial Process Monitoring
- Compact Wireless Products
- External Antenna Elimination

PHYSICAL DIMENSIONS



2.45GHz Version



868 / 916MHz Versions

ACTUAL SIZE



ORDERING INFORMATION

| PART # | DESCRIPTION |
|----------------|----------------------|
| ANT-868-CHP-x | 868MHz Chip Antenna |
| ANT-916-CHP-x | 916MHz Chip Antenna |
| ANT-2.45-CHP-x | 2.45GHz Chip Antenna |

x = "T" for Tape/Reel, "B" for Bulk

All parts are RoHS compliant.
Standard reel is 3,000pcs. (868/916MHz)
1,500pcs (2.45GHz)
Quantities less than reel size are supplied in bulk.

SPECIFICATIONS

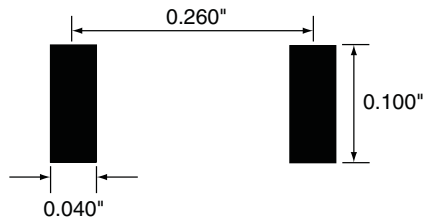
PHYSICAL SPECIFICATIONS

| | 2.45GHz | 868MHz | 916MHz |
|------------------------|--------------------------|---------------------------|---------------------------|
| Dimensions (mm) | 6.5(L) x 2.2(W) x 1.0(H) | 16.0(L) x 3.0(W) x 1.7(H) | 16.0(L) x 3.0(W) x 1.7(H) |
| Operating/Storage Temp | -40 ~ +85°C | -40 ~ +85°C | -40 ~ +85°C |
| Construction | LTCC | LTCC | LTCC |

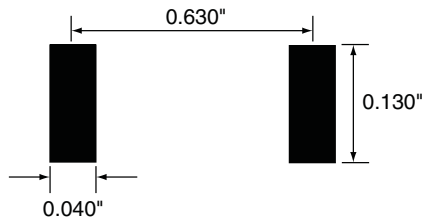
ELECTRICAL PERFORMANCE

| | 2.45GHz | 868MHz | 916MHz |
|------------------|------------------|------------------|------------------|
| Center Frequency | 2.45GHz | 868MHz | 916MHz |
| Bandwidth | 180MHz | 10MHz | 10MHz |
| Wavelength | 1/4-wave | 1/4-wave | 1/4-wave |
| Pattern | Omni-directional | Omni-directional | Omni-directional |
| Polarization | Linear | Linear | Linear |
| VSWR | ≤2.0 (Max.) | ≤2.0 (Max.) | ≤2.0 (Max.) |
| Maximum Gain | +0.5dBi | +0.5dBi | +0.5dBi |
| Impedance | 50Ω | 50Ω | 50Ω |
| Power Handling | 3W (Max.) | 3W (Max.) | 3W (Max.) |

2.4GHz FOOTPRINT



868 & 916MHz FOOTPRINT



PIN CONFIGURATION



| Pin Number | Pin Description |
|------------|--|
| 1 | Feed Termination This pin connects to the transmitter or receiver |
| 2 | Solder Termination This pin is soldered down for physical support only. There is no electrical connection |

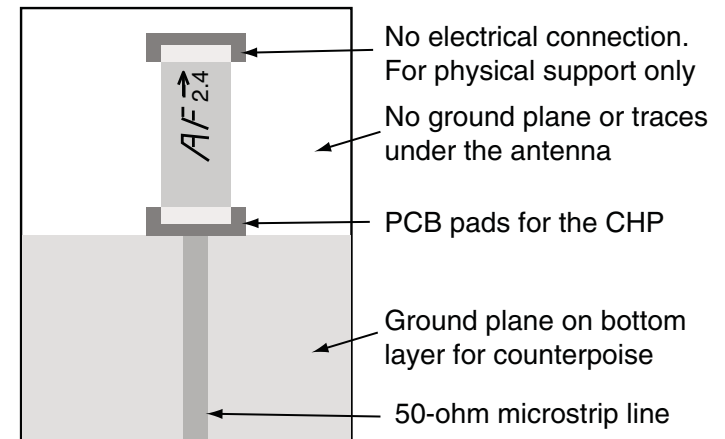
THEORY OF OPERATION

The CHP Series antennas utilize Low Temperature Cofired Ceramic (LTCC) technology to embed the antenna element into a ceramic substrate. Advances in this technology have resulted in materials that are extremely stable over time and temperature, producing an antenna that is highly reliable across a wide range of applications. The high-frequency characteristics of this technology enable exceptional performance in a very small package. The construction techniques for LTCC devices lends itself well to favorable pricing in high volume.

LAYOUT CONSIDERATIONS

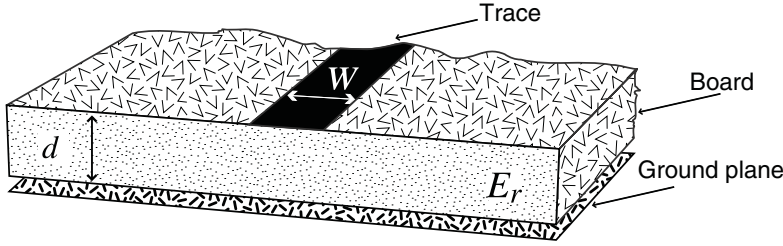
Proper layout is vital to ensure correct operation and optimum performance. Improper placement of planes, traces, or system components will result in nulls or complete de-tuning. Ideally, the antenna will be mounted on the board in such a way as to allow an unobstructed field of view. The area underneath the antenna must be free of components, traces, and planes. Components may be placed to the rear of the antenna in the ground plane counterpoise area. The feed trace from the RF stage to the antenna must be a microstrip trace or coax transmission line and should be kept as short as practical.

The layout of our reference jigs is illustrated on the following pages. While they demonstrate various aspects of a layout, it is not necessary to replicate them exactly. While your board size and layout may differ, it is important to recognize that the counterpoise plays an important role in resonance and stability since it acts, in essence, as part of the antenna. After your own layout is complete, the performance of the antenna in your specific product should be carefully checked using tools like a network analyzer. In some cases, the size of the product's PCB, proximity of the case, or other factors may make a custom version of the antenna necessary. Contact Antenna Factor for more information.



MICROSTRIP DETAILS

A transmission line is a medium whereby RF energy is transferred from one place to another with minimal loss. This is a critical factor, especially in high-frequency products, because the trace leading to the antenna can effectively contribute to the length of the antenna, changing its resonant bandwidth. In order to minimize loss and detuning, some form of transmission line between the antenna and the RF stage should be used, unless the antenna can be placed very close (<1/8in.) to the RF stage. One common form of transmission line is a coax cable, another is the microstrip. This term refers to a PCB trace running over a ground plane that is designed to serve as a transmission line between the RF stage and the antenna. The width is based on the desired characteristic impedance of the line, the thickness of the PCB, and the dielectric constant of the board material. For standard 0.062in-thick FR-4 board material, the trace width would be 111 mils. The correct trace width can be calculated for other widths and materials using the information below. Handy software for calculating microstrip lines is also available on the Antenna Factor website, www.antennafactor.com.



The diagram shows a 3D perspective of a microstrip line. A top layer is labeled 'Trace' with width 'W'. Below it is a layer of thickness 'd' with dielectric constant 'Er'. At the bottom is a 'Ground plane'.

$$E_e = \frac{E_r + 1}{2} + \frac{E_r - 1}{2} \cdot \frac{1}{\sqrt{1 + 12d/W}}$$

$$Z_0 = \begin{cases} \frac{60}{\sqrt{E_e}} \cdot \ln\left(\frac{8d}{W} + \frac{W}{4d}\right) & \text{For } \frac{W}{d} \leq 1 \\ \frac{120\pi}{\sqrt{E_e} \cdot \left(\frac{W}{d} + 1.393 + 0.667 \cdot \ln\left(\frac{W}{d} + 1.444\right)\right)} & \text{For } \frac{W}{d} \geq 1 \end{cases}$$

E_r = Dielectric constant of PCB material

| Dielectric Constant | Width/Height (W/d) | Effective Dielectric Constant | Characteristic Impedance |
|---------------------|--------------------|-------------------------------|--------------------------|
| 4.80 | 1.8 | 3.59 | 50.0 |
| 4.00 | 2.0 | 3.07 | 51.0 |
| 2.55 | 3.0 | 2.12 | 48.0 |

ASSEMBLY CONSIDERATIONS

The antenna is RoHS Compliant and designed to support hand or automated assembly. To avoid damage to the part, the reflow solder guidelines found below should be carefully followed. The antenna is single ended meaning that one pad is electrically connected while the other is for mechanical support only. The antenna terminals are not interchangeable so the polarity indicated in the Pin Configuration section must be observed during assembly.

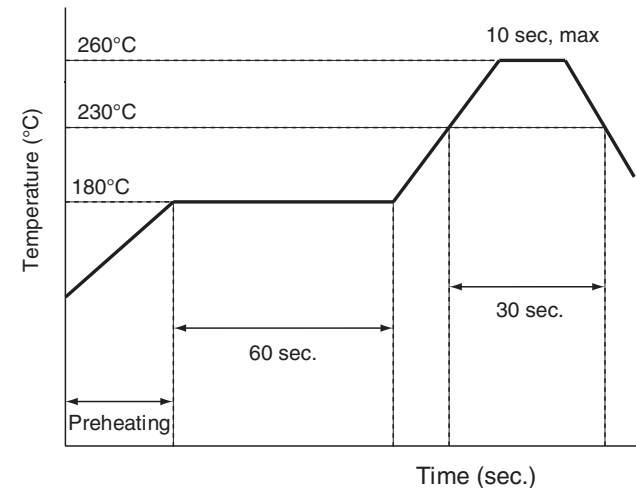
Hand Soldering

This antenna is designed for high-volume automated assembly, however, it may be successfully attached by hand assembly techniques. A hand-solder temperature of 225°C or lower should be used. Do not exceed a 10sec. heating time.

Reflow Temperature Profile

The single most critical stage in the automated assembly process is the reflow process. The reflow profile below should be closely followed since excessive temperatures or transport times during reflow will irreparably damage the antennas. Assembly personnel will need to pay careful attention to the oven's profile to ensure that it meets the requirements necessary to successfully reflow all components while still meeting the limits mandated by the antennas themselves.

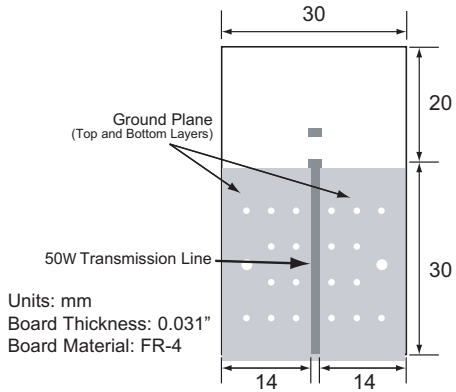
REFLOW SOLDERING PROFILE



Absolute Maximum Solder Times

Hand-Solder Temp. TX +225°C for 10 Sec.
Hand-Solder Temp. RX +225°C for 10 Sec.
Recommended Solder Melting Point +180°C
Reflow Oven: +260°C Max. (See adjoining diagram)

2.4GHZ TEST BOARD



2.4GHz TYPICAL VSWR



2.4GHz TAPE DIMENSIONS

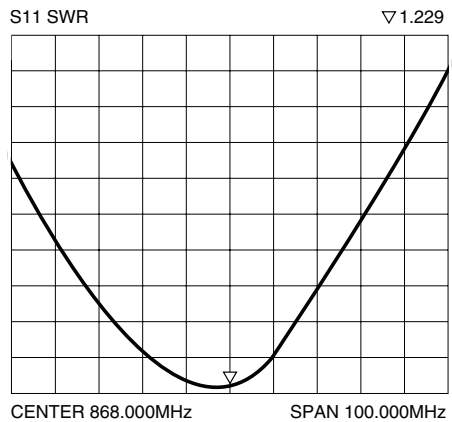


868 & 916MHz TEST BOARD

Board Thickness: 0.062"
Board Material: FR-4



868MHz TYPICAL VSWR



916MHz TYPICAL VSWR



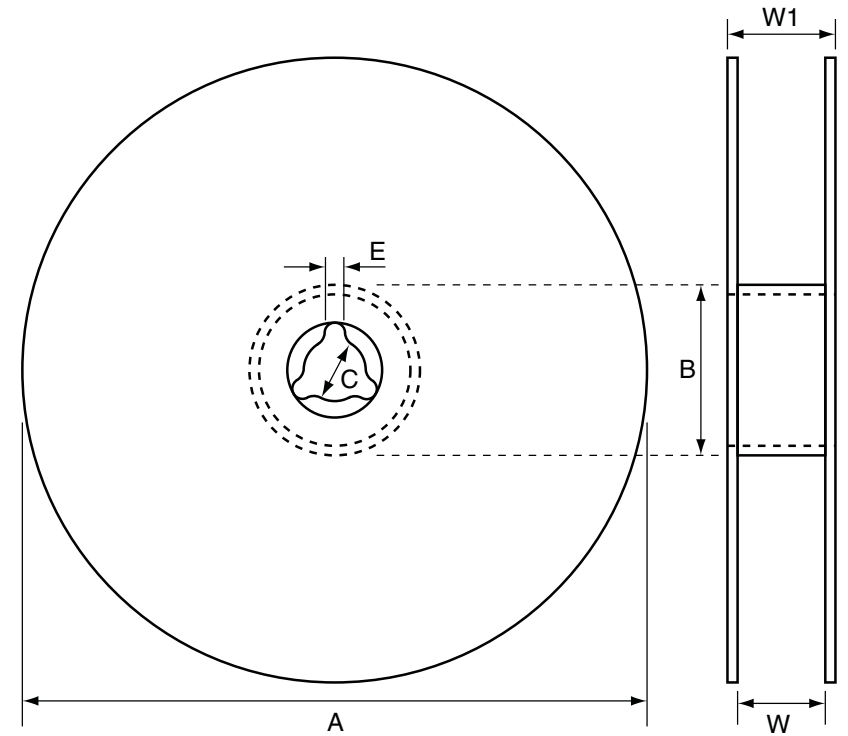
| Symbol | Dimension | Tolerance | Unit |
|--------|-----------|----------------|------|
| A0 | 2.30 | ±0.10 | mm |
| D1 | 1.50 | +0.10 -0.00 | mm |
| D2 | 1.50 | +0.25 -0.00 | mm |
| F | 6.60 | ±0.10 | mm |
| P1 | 8.00 | ±0.10 | mm |
| P2 | 7.50 | ±0.10 | mm |
| P3 | 1.75 | ±0.10 | mm |
| P4 | 4.00 | ±0.10 | mm |
| P5 | 2.00 | ±0.10 | mm |
| T2 | 0.30 | ±0.05 | mm |
| T4 | 1.30 | ±0.10 | mm |
| W | 16.00 | ±0.10 | mm |

868MHz AND 916MHz TAPE DIMENSIONS



| Symbol | Dimension | Tolerance | Unit |
|--------|-----------|-----------|------|
| D1 | 1.50 | ±0.10 | mm |
| D2 | 1.50 | ±0.10 | mm |
| F | 10.6 | ±0.10 | mm |
| P1 | 8.00 | ±0.10 | mm |
| P2 | 11.50 | ±0.10 | mm |
| P3 | 1.75 | ±0.10 | mm |
| P4 | 4.00 | ±0.10 | mm |
| P5 | 2.00 | ±0.10 | mm |
| T2 | 0.30 | ±0.05 | mm |
| T3 | 3.30 | ±0.10 | mm |
| T4 | 1.90 | ±0.10 | mm |
| W | 24.00 | ±0.30 | mm |

REEL DIMENSIONS



| Symbol | 868/916MHz | 2.45GHz | Unit |
|--------------|------------|---------|------|
| QTY per Reel | 3,000 | 1,500 | pcs |
| Tape Width | 24 | 16 | mm |
| A | 330±1 | 180±1 | mm |
| B | 100±0.5 | 62±0.5 | mm |
| C | 13±0.5 | 13±0.2 | mm |
| E | 2.2±0.5 | 2.2±0.5 | mm |
| W | 24±0.5 | 16±0.5 | mm |
| W1 | 28.9±0.2 | 20±0.2 | mm |

MISMATCH CONVERSION TABLE

| VSWR | Insertion Loss (dB) | Power Transmtd (%) | Power Reflected (%) |
|--------|---------------------|--------------------|---------------------|
| 17.391 | -6.87 | 20.57% | 79.43% |
| 11.610 | -5.35 | 29.21% | 70.79% |
| 8.724 | -4.33 | 36.90% | 63.10% |
| 6.997 | -3.59 | 43.77% | 56.23% |
| 5.848 | -3.02 | 49.88% | 50.12% |
| 5.030 | -2.57 | 55.33% | 44.67% |
| 4.419 | -2.20 | 60.19% | 39.81% |
| 3.946 | -1.90 | 64.52% | 35.48% |
| 3.570 | -1.65 | 68.38% | 31.62% |
| 3.010 | -1.26 | 74.88% | 25.12% |
| 2.615 | -0.97 | 80.05% | 19.95% |
| 2.323 | -0.75 | 84.15% | 15.85% |
| 2.100 | -0.58 | 87.41% | 12.59% |
| 1.925 | -0.46 | 90.00% | 10.00% |
| 1.433 | -0.14 | 96.84% | 3.16% |
| 1.222 | -0.04 | 99.00% | 1.00% |
| 1.119 | -0.01 | 99.68% | 0.32% |
| 1.065 | 0.00 | 99.90% | 0.10% |
| 1.034 | 0.00 | 99.97% | 0.03% |
| 1.020 | 0.00 | 99.99% | 0.01% |

ON-LINE RESOURCES



www.antennafactor.com

- Latest News
- Data Guides
- Application Notes
- Knowledge Base
- Custom Antennas



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www.connectorcity.com

Through its Connector City division, Linx offers a wide selection of high-quality RF connectors, including FCC-compliant types such as RP-SMA that are an ideal match for our modules and antennas. Connector City focuses on high-volume OEM requirements, which allows standard and custom RF connectors to be offered at a remarkably low cost.





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- Защита от снятия компонента с производства.



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